

BSS138P 60 V, 360 mA N-channel Trench MOSFET Rev. 1 – 2 November 2010

Product data sheet

1. Product profile

1.1 General description

N-channel enhancement mode Field-Effect Transistor (FET) in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

1.2 Features and benefits

- Logic-level compatible
- Very fast switching
- Trench MOSFET technology
- AEC-Q101 qualified

1.3 Applications

- Relay driver
- High-speed line driver
- Low-side loadswitch
- Switching circuits

1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{DS}	drain-source voltage	$T_{amb} = 25 \ ^{\circ}C$	-	-	60	V
V _{GS}	gate-source voltage	$T_{amb} = 25 \ ^{\circ}C$	-	-	±20	V
I _D	drain current	T _{amb} = 25 °C; V _{GS} = 10 V	[1] -	-	360	mA
R _{DSon}	drain-source on-state resistance	T _j = 25 °C; V _{GS} = 10 V; I _D = 300 mA	[2] _	0.9	1.6	Ω

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 1 cm².

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2. Pinning information

Table 2.	Pinning			
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		-
2	S	source		
3	D	drain		G (F) mbb076 S

3. Ordering information

Table 3. Ordering information					
Type number	Package				
	Name	Description	Version		
BSS138P	TO-236AB	plastic surface-mounted package; 3 leads	SOT23		

4. Marking

Table 4. Marking codes	
Type number	Marking code ^[1]
BSS138P	AN*

[1] * = placeholder for manufacturing site code

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Parameter	Conditions	Min	Max	Unit
drain-source voltage	T _{amb} = 25 °C	-	60	V
gate-source voltage	T _{amb} = 25 °C	-	±20	V
drain current	V _{GS} = 10 V	<u>[1]</u>		
	T _{amb} = 25 °C	-	360	mA
	T _{amb} = 100 °C	-	230	mA
peak drain current	$\begin{array}{l} T_{amb} = 25 \ ^{\circ}C; \\ single \ pulse; \ t_p \leq 10 \ \mu s \end{array}$	-	1.2	А
	drain-source voltage gate-source voltage drain current	$\label{eq:constraint} \begin{array}{ll} \mbox{drain-source voltage} & T_{amb} = 25 \ ^{\circ}C$ \\ \mbox{gate-source voltage} & T_{amb} = 25 \ ^{\circ}C$ \\ \mbox{drain current} & V_{GS} = 10 \ V$ \\ \hline T_{amb} = 25 \ ^{\circ}C$ \\ \hline T_{amb} = 100 \ ^{\circ}C$ \\ \hline T_{amb} = 25 \ ^{\circ}C; \end{array}$	$\begin{array}{ccc} \text{drain-source voltage} & T_{amb} = 25 \ ^{\circ}\text{C} & - \\ \text{gate-source voltage} & T_{amb} = 25 \ ^{\circ}\text{C} & - \\ \text{drain current} & \frac{V_{GS} = 10 \ \text{V}}{T_{amb} = 25 \ ^{\circ}\text{C}} & - \\ \hline & T_{amb} = 100 \ ^{\circ}\text{C} & - \\ \hline & T_{amb} = 100 \ ^{\circ}\text{C} & - \\ \hline & T_{amb} = 25 \ ^{\circ}\text{C}; & - \\ \end{array}$	$\begin{array}{c c} drain-source \ voltage \\ gate-source \ voltage \\ drain \ current \\ \end{array} \begin{array}{c} T_{amb} = 25 \ ^{\circ}C & - & 60 \\ T_{amb} = 25 \ ^{\circ}C & - & \pm 20 \\ \end{array}$ $\begin{array}{c} T_{amb} = 25 \ ^{\circ}C & - & \pm 20 \\ \hline T_{amb} = 10 \ ^{\circ}C & - & 360 \\ \hline T_{amb} = 100 \ ^{\circ}C & - & 230 \\ \end{array}$ $\begin{array}{c} peak \ drain \ current \\ \hline T_{amb} = 25 \ ^{\circ}C; & - & 1.2 \\ \end{array}$

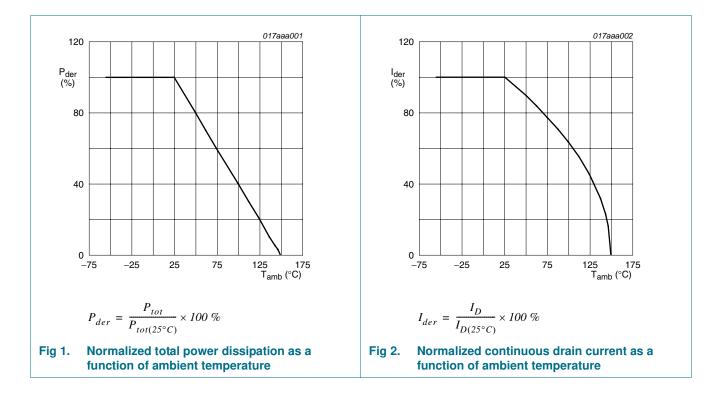
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Symbol	Parameter	Conditions	Min	Max	Unit
P _{tot} total power of	total power dissipation	ower dissipation $T_{amb} = 25 \text{ °C}$	[2] -	350	mW
			[1] -	420	mW
		T _{sp} = 25 °C	-	1140	mW
Tj	junction temperature			150	°C
T _{amb}	ambient temperature		-55	+150	°C
T _{stg}	storage temperature		-65	+150	°C
Source-d	rain diode				
I _S	source current	T _{amb} = 25 °C	<u>[1]</u> -	360	mA

 Table 5.
 Limiting values ...continued

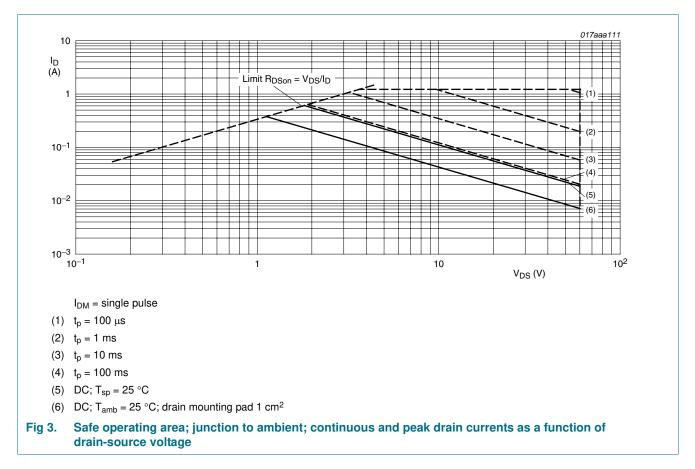
[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 1 cm².

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.



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6. Thermal characteristics

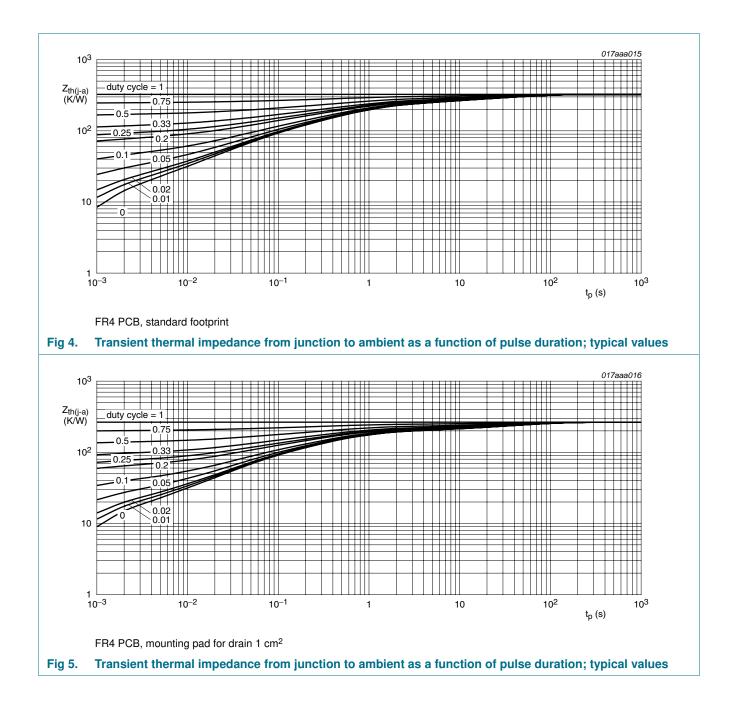
Table 6.Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient	in free air	<u>[1]</u> -	310	370	K/W
			[2] _	260	300	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		-	-	115	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 1 cm².

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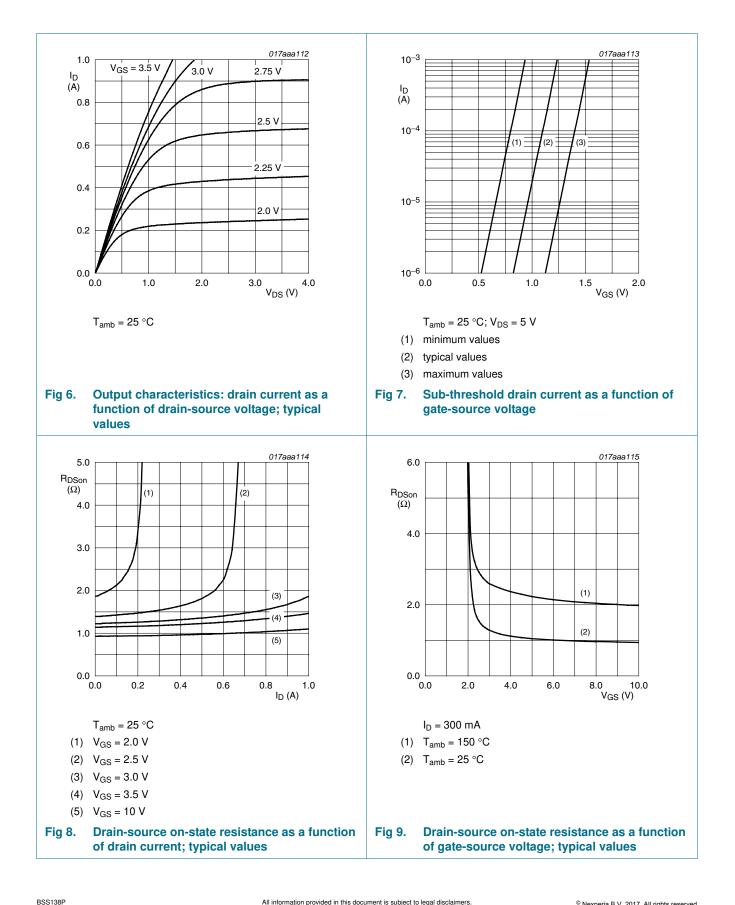
7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
V _{(BR)DSS}	drain-source breakdown voltage	$I_D = 10 \ \mu\text{A}; \ V_{GS} = 0 \ V$	60	-	-	V
V _{GS(th)}	gate-source threshold voltage	$I_D = 250 \ \mu\text{A}; \ V_{DS} = V_{GS}$	0.9	1.2	1.5	V
I _{DSS}	drain leakage current	$V_{DS} = 60 \text{ V}; V_{GS} = 0 \text{ V}$				
		T _j = 25 °C	-	-	1	μA
		T _j = 150 °C	-	-	10	μA
I _{GSS}	gate leakage current	$V_{GS}=\pm 20~V;~V_{DS}=0~V$	-	-	100	nA
R _{DSon}	drain-source on-state		<u>[1]</u>			
	resistance	$V_{GS} = 5 \text{ V}; I_D = 50 \text{ mA}$	-	1	2	Ω
		V_{GS} = 10 V; I _D = 300 mA	-	0.9	1.6	Ω
9fs	forward transconductance	V_{DS} = 10 V; I _D = 200 mA	<u>[1]</u> _	700	-	mS
Dynamic	characteristics					
Q _{G(tot)}	total gate charge	I _D = 300 mA;	-	0.72	0.8	nC
Q _{GS}	gate-source charge	V _{DS} = 30 V; V _{GS} = 4.5 V	-	0.14	-	nC
Q _{GD}	gate-drain charge	$V_{GS} = 4.5 V$	-	0.24	-	nC
C _{iss}	input capacitance	$V_{GS} = 0 V; V_{DS} = 10 V;$	-	38	50	pF
C _{oss}	output capacitance	f = 1 MHz	-	7	-	pF
C _{rss}	reverse transfer capacitance		-	4	-	pF
t _{d(on)}	turn-on delay time	V _{DS} = 50 V;	-	2	6	ns
t _r	rise time	$R_{L} = 250 \Omega;$	-	3	-	ns
t _{d(off)}	turn-off delay time	– V _{GS} = 10 V; R _G = 6 Ω	-	9	20	ns
t _f	fall time	_ ~	-	4	-	ns
Source-di	ain diode					
V _{SD}	source-drain voltage	I _S = 115 mA; V _{GS} = 0 V	0.47	0.75	1.1	V

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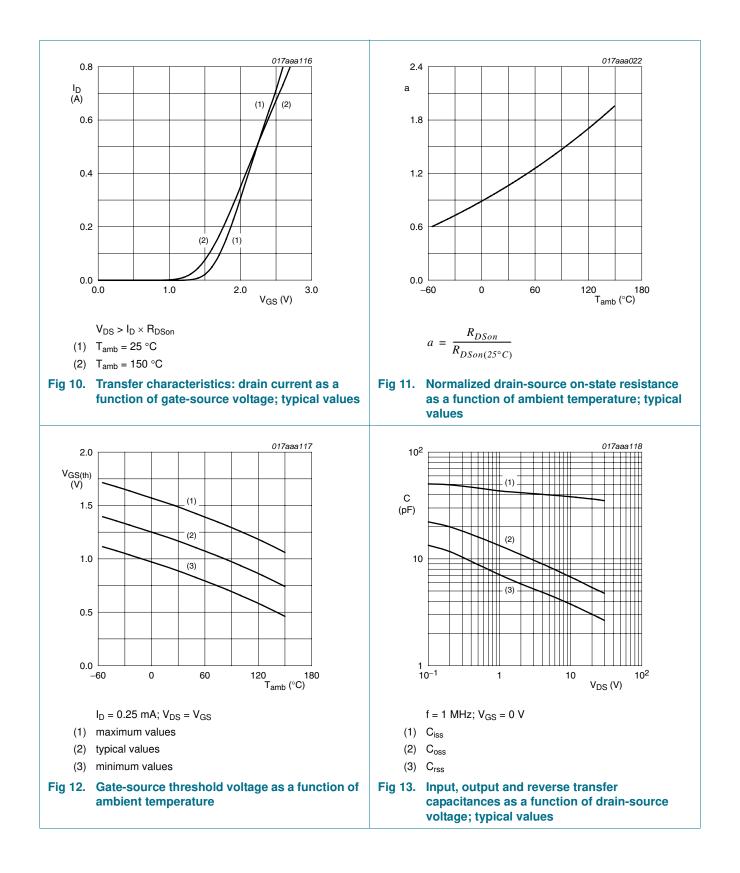
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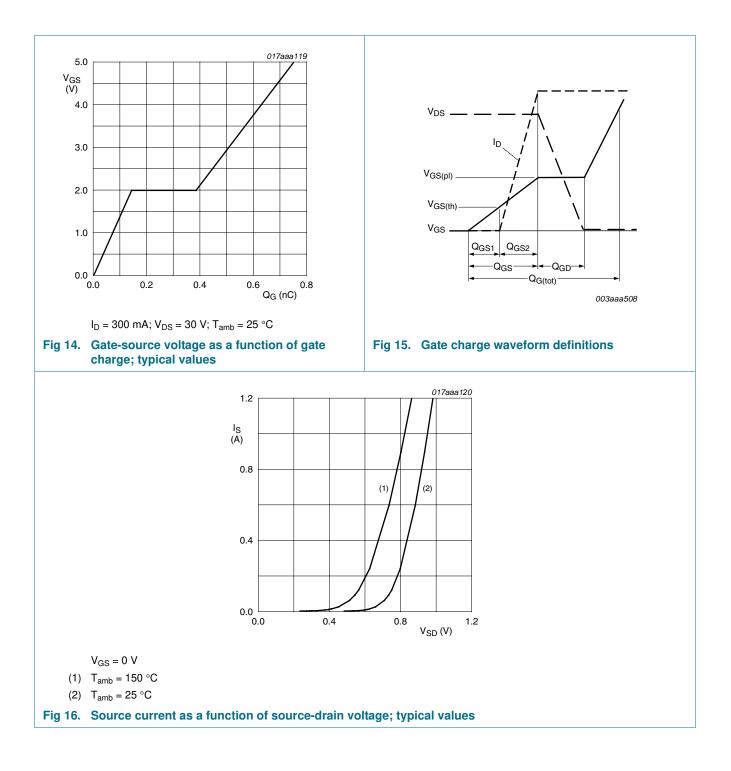
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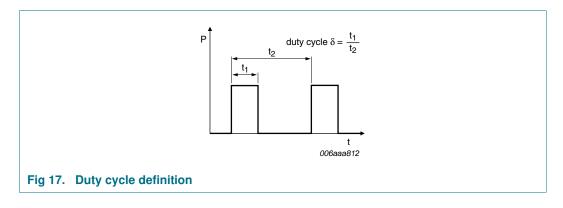


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8. Test information



8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

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9. Package outline

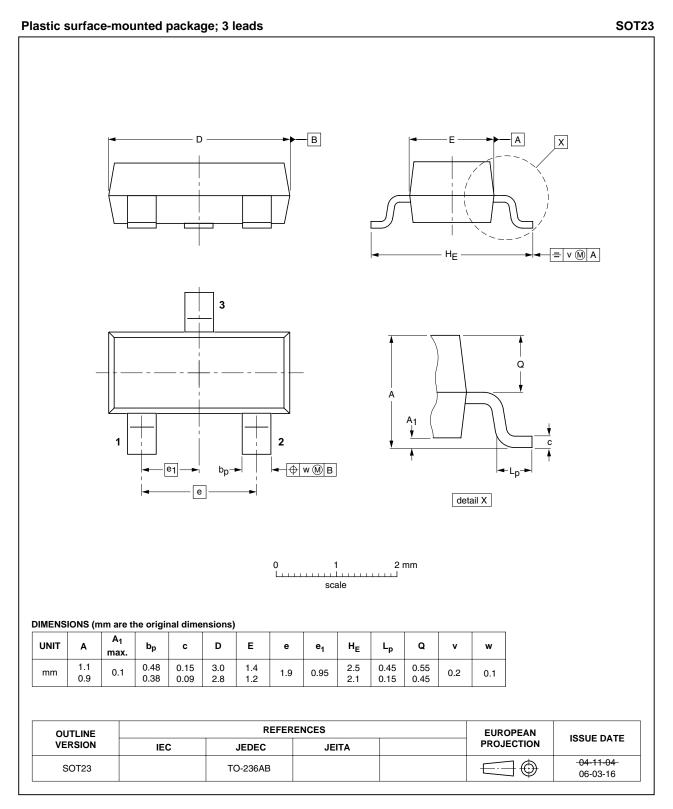
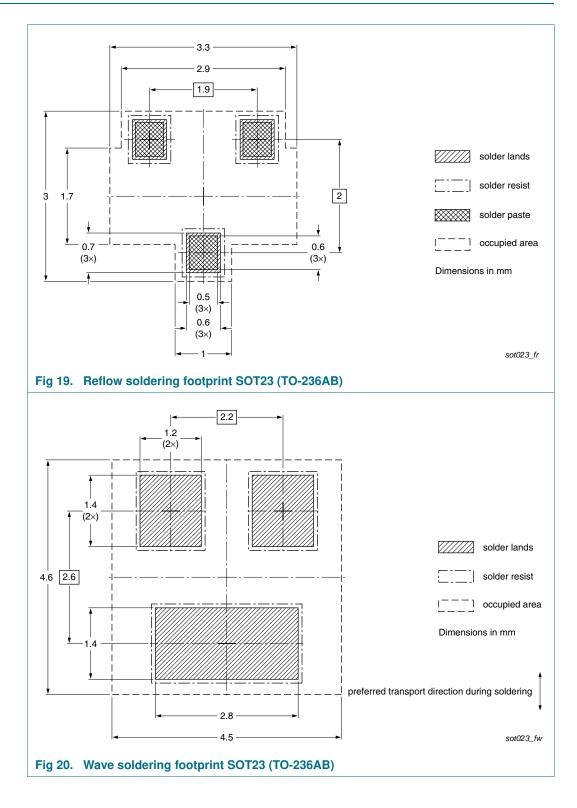


Fig 18. Package outline SOT23 (TO-236AB)

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10. Soldering



11. Revision history

Table 8. Revis	ion history			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BSS138P v.1	20101102	Product data sheet	-	-

12. Legal information

12.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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